IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT:

Dongtai Liu

APPLICATION NO.:

Div. of 09/703,324

FILING DATE:

HEREWITH

TITLE:

ELECTRICAL ISOLATION TECHNIQUES FOR DSL MODEM

PARENT EXAMINER:

Jean B. Corrielus

PARENT

2631

GROUP ART UNIT:

ATTY. DKT. NO.:

21676-08308

MAIL STOP PATENT APPLICATION COMMISSIONER FOR PATENTS P. O. BOX 1450 ALEXANDRIA, VA 22313-1450 EXPRESS MAIL NO. EV334258260US

INFORMATION DISCLOSURE STATEMENT Under 37 CFR §§ 1.56 and 1.97-98

SIR:

Pursuant to the provisions of 37 CFR §§ 1.56 and 1.97-98, enclosed herewith is modified form PTO/SB/08A listing references for consideration by the Examiner.

The filing of this Information Disclosure Statement shall not be construed as a representation regarding the completeness of the list of references, or that inclusion of a reference in this list is an admission that it is prior art or is pertinent to this application, or that a search has been made, or as an admission that the information listed is, or may be considered to be, material to patentability, or that no other material information exists, and shall not be construed as an admission against interest in any manner.

This Information Disclosure Statement is being filed:

\boxtimes	within three months of the filing date of the application, or date of entry
	into the national stage of an international application, or before the mailing
	date of a first office action on the merits, whichever event last occurred;
	before the mailing of a first official action after the filing of a request for
	continued examination (RCE) under 37 CFR § 1.114;
	after three months of the filing date of this national application or the date
	of entry of the national stage in an international application, or after the
	mailing date of the first official action on the merits, whichever event last
	occurred, but before the mailing date of the first to occur of either: (1) a

	final ac	tion un	der 37 CFR §1.113; or (2) an action that otherwise closes
	prosecu	ition in	the application, and:
		attach	ed hereto is the fee set forth under 37 CFR §1.17(p) for
		submi	ission of this Information Disclosure Statement under 37
		CFR.	§ 1.97(c); OR
		Appli	cant certifies pursuant to 37 CFR § 1.97(e) that:
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			Disclosure Statement was first cited in a communication
			from a foreign patent office in a counterpart foreign
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			and, to the knowledge of the person signing this
			certification after making reasonable inquiry, no item of
			information contained in this Statement was known to any
			individual designated under 37 CFR § 1.56(c) more than
			three months prior to the filing of this Statement;
	before	the pay	yment of the issue fee but after the mailing date of the first to
_			er: (1) a final action under 37 CFR § 1.113; or (2) an action
			e closes prosecution in the application, and:
			cant certifies pursuant to 37 CFR. § 1.97(e) that:
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			or
		П	no item of information contained in this Information
		_	Disclosure Statement was cited in a communication from a
			foreign patent office in a counterpart foreign application
			and, to the knowledge of the person signing this
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			information contained in this Statement was known to any
			individual designated under 37 CFR § 1.56(c) more than
			three months prior to the filing of this Statement; AND
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			ssion of this Information Disclosure Statement under 37
			§ 1.97(c); OR
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21676/01000/SF/5107390.1 2

	contained in this Information	ne issue fee. Applicant request that the information mation Disclosure Statement be placed in the file 1.97(i), although the information may not be 2TO.
	This application relies, under application No. 09/703,324, fitherein are hereby referenced,	35 U.S.C. § 120, on the earlier filing date of prior iled on October 31, 2000, and the references cited but are not required to be provided in this
	cited in a communication from and the communication was n	rained in this Information Disclosure Statement was in a foreign patent office in a counterpart application, ot received by any individual designated in 37 CFR is prior to the filing of this Information Disclosure
	Applicant submits that no fee Disclosure Statement.	is required for the consideration of this Information
Consi	deration of the listed references	and favorable action are solicited.
		Respectfully submitted,
		DONGTAI LIU
Dated: <u>Septe</u>		By:
		Tel.: (650) 335-7133 Fax: (650) 938-5200

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	Substitute for f	orm 1449/	VPTO	Complete if Known		
	D TIO.		01 00UDE	Application No.	Div. of 09/703,324	
			CLOSURE	Filing Date	HEREWITH	
STAT	EMENT I	BY AF	PPLICANT	First Named Inventor	Dongtai Liu	
				Parent Art Unit	2631	
				Parent Examiner Name	Jean B. Corrielus	
Sheet	1	of	1	Attorney Docket Number	21676-08308	

			U.S. PATENT	DOCUMENTS
		Document No.		
Examiner Initials*	Cite No. ¹	Number – Kind Code ² (if known)	Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
	A1	US-5,369,666	11-29-1994	Folwell et al.
	A2	US-5,555,293	09-10-1996	Krause
	АЗ	US-5,574,404	11-12-1996	Le Bars
	A4	US-5,655,010	08-05-1997	Bingel
	A5	US-5,774,541	06-30-1998	Krause
	A6	US-5,875,235	02-23-1999	Mohajeri
	A7	US-6,081,586 A	06-27-2000	Rahamim et al.
	A8	US-6,169,801 B1	01-02-2001	Levasseur et al.
	A9	US-6,351,530 B1	02-26-2002	Rahamim et al.
	A10	US-6,359,973 B1	03-19-2002	Rahamim et al.
	A11	US-6,407,691 B1	06-18-2002	Yu
	A12	US-6,445,330 B1	09-03-2002	Thomsen et al.
	A13	US-2002/0126806 A1	09-12-2002	Rahamim et al.
-	A14	US-2002/0186824 A1	12-12-2002	Sabodash et al.

			FOREIGN PA	TENT DOCUMENTS	
		Foreign Patent Document			
Examiner Initials*	Cite No. ¹	Country Code ³ – Number ⁴ Kind Code ⁵ (if known)	Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	T ^e
	B1	WO 99/48272	09-23-1999	Levasseur et al.	
	B2	WO 00/30333	05-25-2000	Conexant Systems, Inc.	
	В3	WO 00/30336	05-25-2000	Conexant Systems, Inc.	

Examiner	Date
	Considered
Signature	Considered

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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